

Features

- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- High Conductance
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: SOD123
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208 Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe)
- Polarity: Cathode Band
- Marking Information: See Page 2
- Type Code: BAV19W: A8 or T2 or T3
BAV20W: T2 or T3
BAV21W: T3
- Ordering Information: See Page 2
- Weight: 0.01 grams (approximate)

SOD123



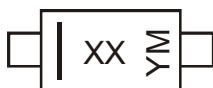
TOP VIEW

Ordering Information (Note 6)

Part Number	Case	Packaging
BAV19W-7-F	SOD-123	3000/Tape and Reel
BAV20W-7-F	SOD123	3000/Tape and Reel
BAV20WQ-7-F	SOD123	3000/Tape and Reel
BAV21W-7-F	SOD123	3000/Tape and Reel
BAV21WQ-7-F	SOD123	3000/Tape and Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>

Marking Information



XX = Product Type Marking Code (See Page 1)
 YM = Date Code Marking
 Y = Year (ex: A = 2013)
 M = Month (ex: 9 = September)

Date Code Key

Year	1998	1999	2000	...	2008	2009	2010	2011	2012	2013	2014	2015	2016	2017	2018
Code	J	K	L	...	V	W	X	Y	Z	A	B	C	D	E	F

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	BAV19W	BAV20W	BAV21W	Unit
Non-Repetitive Peak Reverse Voltage	V _{RM}	120	200	250	V
Peak Repetitive Reverse Voltage	V _{RRM}	100	150	200	V
Working Peak Reverse Voltage	V _{RWM}				
DC Blocking Voltage	V _R				
RMS Reverse Voltage	V _{R(RMS)}	71	106	141	V
Forward Continuous Current	I _{FM}	400			mA
Average Rectified Output Current	I _O	200			mA
Non-Repetitive Peak Forward Surge Current @t = 1.0ms	I _{FSM}	2.5			A
@t = 1.0s		0.5			
Repetitive Peak Forward Surge Current	I _{FRM}	625			mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P _D	250	mW
Thermal Resistance Junction to Ambient Air (Note 6)	R _{θJA}	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	V _{(BR)R}	120 200 250	—	V	I _R = 100μA
Forward Voltage	V _{FM}	—	1.0 1.25	V	I _F = 100mA I _F = 200mA
Peak Reverse Current @ Rated DC Blocking Voltage (Note 5)	I _{RM}	—	100 15	nA μA	T _J = +25°C T _J = +100°C
Total Capacitance	C _T	—	5.0	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{rr}	—	50	ns	I _F = I _R = 30mA, I _{rr} = 0.1 x I _R , R _L = 100W

Notes: 5. Short duration pulse test used to minimize self-heating effect.
6. Part mounted on FR-4 PC board with minimum recommended pad layout, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>

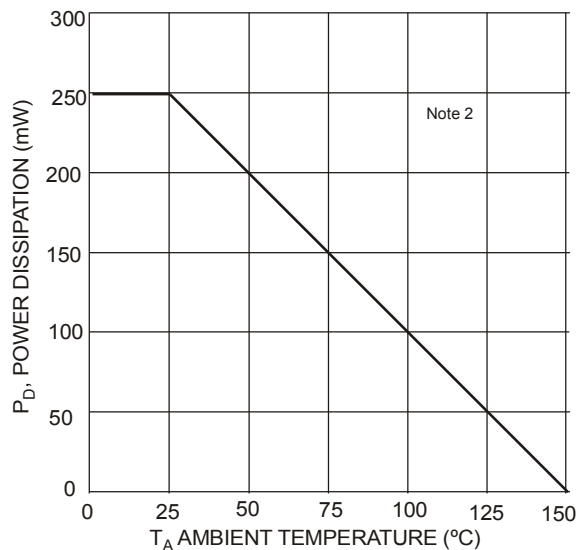


Fig. 1 Power Derating Curve

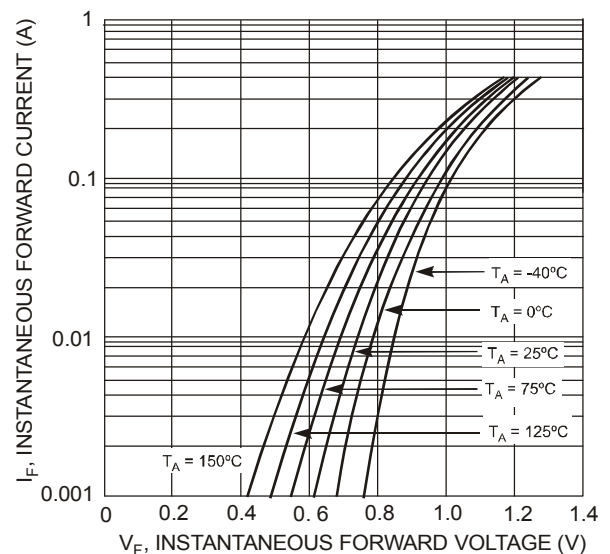


Fig. 2 Typical Forward Characteristics

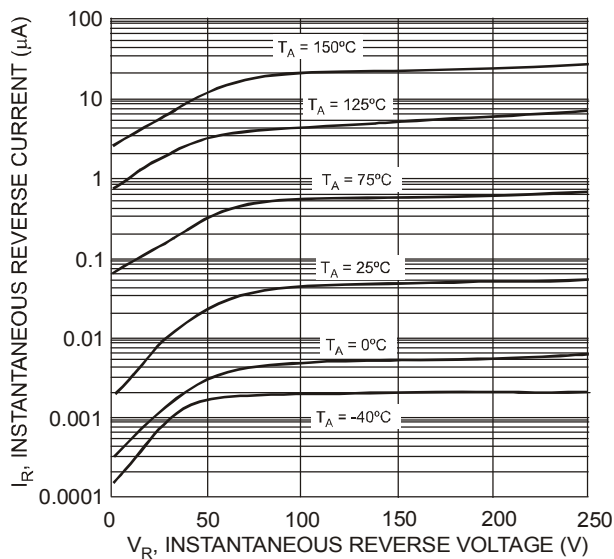


Fig. 3 Typical Reverse Characteristics

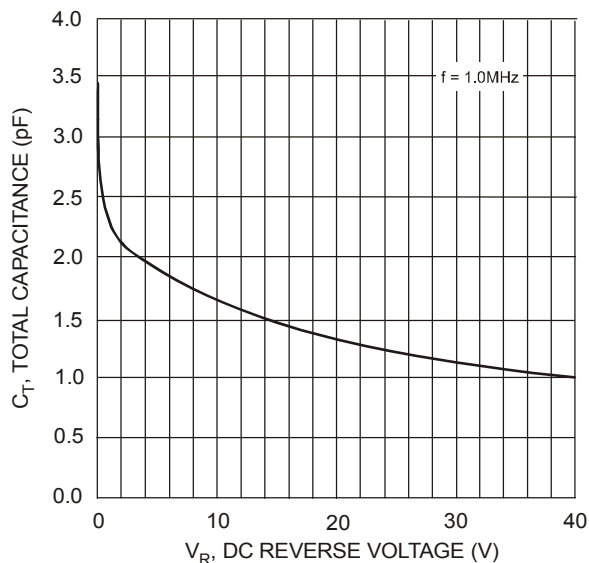
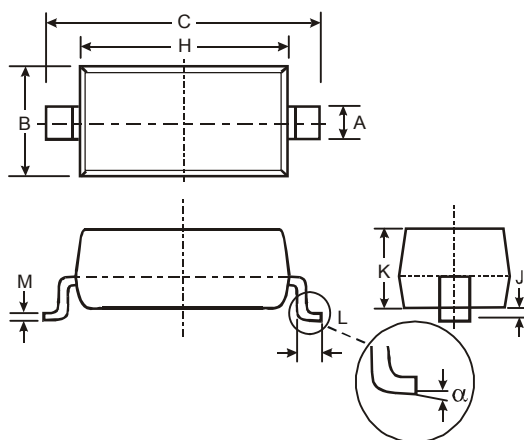


Fig. 4 Total Capacitance vs. Reverse Voltage

Package Outline Dimensions

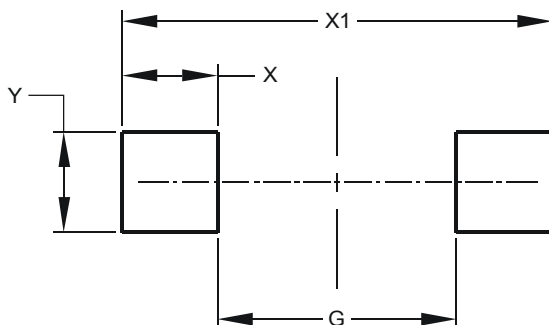
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SOD123		
Dim	Min	Max
A	0.55 Typ	
B	1.40	1.70
C	3.55	3.85
H	2.55	2.85
J	0.00	0.10
K	1.00	1.35
L	0.25	0.40
M	0.10	0.15
α	0	8°
All Dimensions in mm		

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
G	2.250
X	0.900
X1	4.050
Y	0.950

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